# **EEE 133 Key concepts and Equations**

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# 1 Diode Models and Circuits

# 1.1 History of Electronics

- 1. 1904: John Fleming invented vacuum tubes. First time electron flow is controlled in non-conducting medium
  - (a) if the cathode is heated, some electrons can escape
  - (b) if a voltage is applied (+) on anode (-) on cathode, there will be current
- 2. 1906: the grid was added to control the current between the anode and cathode
  - (a) vacuum tubes allowed the development of amplifiers, transmitters, receivers, signal processor
- 3. 1946: the ENIAC computer was completed. it could execute 5000 additions per second
- 4. 1947: invention of transistor by Shockley, Bardeen, Brattain at the Bell Labs
  - (a) they were point-contact transistors
- 5. 1948: Schockley invented the BJT. the BJT is monolithic (containted in a single semiconductor crystal)
- 6. 1958: the first Integrated Circuits (IC) was invented by Jack Kilby of Texas Instruments (non-monolithic)
- 7. 1959: the first monolithic IC was developed by Robert Noyce at Fairchild Semiconduction
  - (a) uses silicon instead of germanium
  - (b) 2 interconnected BJT transistor
  - (c)  $SiO_2$  insulator, Al interconnection
  - (d) planar IC, 0.06 in diameter
- 8. Bipolar ICs with BJT devices domidated until early 80s
  - (a) S/M/L Scale Integration: 10, 100, 1000 transistors
- 9. 1959: MOS ICs started in the 60s after the MOS transistor was develooed at Bell Labs
  - (a) easier to fabricate than bipolar
  - (b) uses less power
  - (c) can fit more transistor in the same silicon area
  - (d) slower than bipolar IC
  - (e) less robust than bipolar IC

- 10. MOS ICs
  - (a) early 70s: MOS technology improved in speed and reliability
  - (b) first microprocessor: Intel 4004 (1971)
  - (c) emergence of VLSI (>10000 trasistors)
  - (d) microprocessors evolved into microcontrollers (MCUs) ad system on a chip (SOCs)
- 11. Moore's Law: the transistor density would double every two years

#### 1.2 Piecewise Linear Diode Models

- 1. 1st Approximation: (when  $v_s \gg V_T$ )
  - (a) Open when  $v_D < 0$
  - (b) Short when  $v_D \ge 0$
- 2. 2nd Approximation (when above condition not satisfied):
  - (a) Open when  $v_D < V_T$
  - (b) Voltage of  $V_T$  when  $v_D \geq V_T$
- 3. 3rd Approximation (2nd with resistor R in series)
  - (a) Open when  $v_D < V_T$
  - (b) Voltage of  $V_T$  in series with resistance R when  $v_D \ge V_T$
- 4. To determine diode state:
  - (a) Assume it is conducting
  - (b) Check direction of current
  - (c) If current is from anode to cathode, the assumption is correct and equivalent circuit is valid
  - (d) Otherwise, diode should be open
- 5. Another method:
  - (a) Replace diode with open circuit
  - (b) Determine the voltage across the diode terminals (+) on anode, (−) on cathode
  - (c) If  $v_D$  < the needed threshold, assumption is correct
  - (d) Otherwise, diode should be replaced with the appropriate model

# 1.3 Practical Diode Circuits

1. Half Wave Rectifier

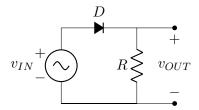


Figure 1: Half Wave Rectifier

(a) When diode is IDEAL:

$$v_{OUT} = \begin{cases} 0, & v_{IN} < 0 \\ v_{IN} & v_{IN} \ge 0 \end{cases}$$

(b) When diode has constant voltage model:

$$v_{OUT} = \begin{cases} 0, & v_{IN} < V_T \\ v_{IN} - V_T & v_{IN} \ge V_T \end{cases}$$

2. Full Wave Rectifier ( $v_1 = v_2$ )

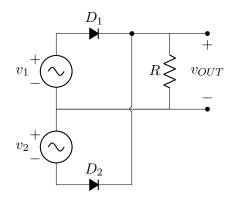


Figure 2: Full Wave Rectifier

(a) When diode is IDEAL:

$$v_{OUT} = |v_{IN}|$$

(b) When diode has constant voltage model

$$v_{OUT} = \left\{ egin{array}{ll} v_1 - V_T, & v_1 > V_T \\ -v_2 - V_T, & v_2 < -V_T \\ 0 & ext{otherwise} \end{array} 
ight.$$

(c) This requires a transformer with center-tapped secondary ( $n_1:n_2=1:2$ )

# 3. Full Wave Bridge Rectifier

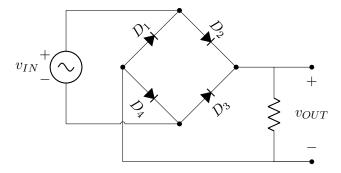


Figure 3: Full Wave Bridge Rectifier

(a) When diode is IDEAL:

$$v_{OUT} = |v_{IN}|$$

(b) When diode has constant voltage model:

$$v_{OUT} = \left\{ egin{array}{ll} v_1 - 2V_T, & v_1 > 2V_T \\ -v_2 - 2V_T, & v_2 < -2V_T \\ 0 & ext{otherwise} \end{array} 
ight.$$

# 4. Positive Clipper

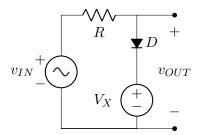


Figure 4: Positive Clipper

(a) 
$$v_{OUT} = \left\{ egin{array}{ll} V_X + V_T, & v_{IN} - V_X > V_T \\ v_{IN}, & v_{IN} - V_X < V_T \end{array} \right.$$

### 5. Negative Clipper

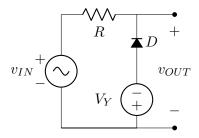


Figure 5: Negative Clipper

(a) 
$$v_{OUT} = \begin{cases} -\left(V_{Y} + V_{T}\right), & -V_{Y} - v_{IN} > V_{T} \\ v_{IN}, & -V_{Y} - v_{IN} < V_{T} \end{cases}$$

6. The positive and negative clippers can be combined

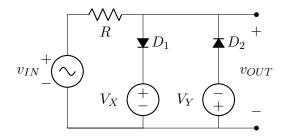


Figure 6: Positive and Negative Clipper

(a) 
$$v_{OUT}=\left\{egin{array}{ll} V_X+V_T, & v_{IN}-V_X>V_T \\ & -\left(V_Y+V_T\right), & -V_Y-v_{IN}>V_T \\ & v_{IN}, & ext{otherwise} \end{array}
ight.$$

#### 7. Peak Detector

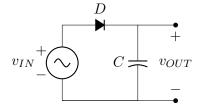


Figure 7: Peak Detector

- (a) Let the time  $t_1$  be the first time the input reaches its maximum value  $V_P$  and  $t_0$  be the time to reach  $V_T$
- (b) When diode is IDEAL:

$$v_{OUT} = \begin{cases} v_{IN}, & t < t_1 \\ V_P, & t \ge t_1 \end{cases}$$

(c) When diode has constant voltage model:

$$v_{OUT} = \begin{cases} 0, & 0 \le t < t_0 \\ v_{IN} - V_T, & t_0 \le t < t_1 \end{cases}$$
$$V_P - V_T \quad t_1 \le t$$

8. Peak Detector with Load Resistor (Ideal Diode)

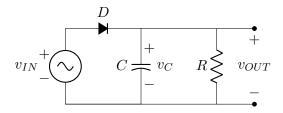


Figure 8: Peak Detector with load resistor

(a) Let the time  $t_1$  be the first time the input reaches its maximum value  $V_P$  and the period be T. When the capacitor voltage decays, let time  $t_2$  be when  $v_C = v_{IN}$  again

$$\text{(b) } v_{OUT} = \left\{ \begin{array}{ll} v_{IN}, & t < t_1 \\ V_P \exp\left(-\frac{t-t_1}{RC}\right), & t_1 \leq t < t_2 \\ \\ v_{IN}, & t_2 \leq t < t_1 + T \\ \\ V_P \exp\left(-\frac{t-(t_1+T)}{RC}\right), & t_1 + T \leq t < t_2 + T \\ \\ \vdots & \vdots \end{array} \right.$$

9. Negative Clamper (ideal diode)

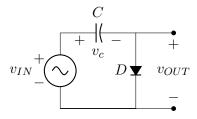


Figure 9: Negative Clamper

- (a) Let the time  $t_1$  be the first time the input reaches its maximum value  $V_P$
- (b) This is similar to the peak detector, only that  $v_{OUT}=v_{IN}-v_{C}$  where  $v_{C}$  follows the characteristic of the peak detector

(c) 
$$v_C = \left\{ egin{array}{ll} v_{IN}, & t < t_1 \ & & \\ V_P, & t_1 \leq t \end{array} \right.$$

(d) 
$$v_{OUT} = \left\{ egin{array}{ll} 0, & t < t_1 \\ \\ v_{IN} - V_P, & t \geq t_1 \end{array} \right.$$

10. Positive Clamper (ideal diode)

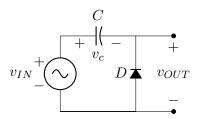


Figure 10: Positive Clamper

(a) Let the period be T

(b) 
$$v_C = \begin{cases} 0, & 0 \le t < T/2 \\ v_{IN}, & T/2 \le t < 3T/4 \\ -V_P, & 3T/4 \le t \end{cases}$$

(c) 
$$v_{OUT} = \begin{cases} v_{IN}, & 0 \le t < T/2 \\ 0, & T/2 \le t < 3T/4 \\ v_{IN} + V_P, & 3T/4 \le t \end{cases}$$

# 1.4 Exponential Diode Model

1. Shockley's Diode Equation

$$i_D = I_S \left[ \exp\left(\frac{v_D}{\eta V_T}\right) - 1 \right] \tag{1}$$

- (a)  $v_D$ : diode voltage with positive at anode
- (b)  $i_D$ : diode current from anode to cathode
- (c)  $I_S$ : reverse saturation current due to minority carriers.  $10^{-15} {\rm A} < I_s < 10^{-9} {\rm A}$
- (d)  $\eta$ : ideality factor,  $1 < \eta < 2$ ; close to 1 for well fabricated diodes
- (e)  $V_T$ : thermal voltage,  $V_T = \frac{kT_K}{e} \approx \frac{T_K}{11600}$
- 2. for typical operating voltages (forward biased):  $\exp\left(\frac{v_D}{\eta V_T}\right)\gg 1 \implies i_D\approx I_S\exp\left(\frac{v_D}{\eta V_T}\right)$
- 3. for typical reverse bias voltages,  $\exp\left(\frac{v_D}{\eta V_T}\right) \ll 1 \implies i_D \approx -I_S$

# 1.5 Small Signal Model

1.  $v_D = V_D + v_d$ 

2.  $i_D = I_D + i_d$ .  $I_D$  is calculated using large signal analysis

3. if the amplitude of  $v_d$  is very small, the diode characteristic equation is approximately a line with conductance  $g_d = \frac{\partial i_D}{\partial v_D} = \frac{I_S}{\eta V_T} \exp\left(\frac{v_D}{\eta V_T}\right) \approx \frac{I_D}{\eta V_T} \implies r_d = \frac{\eta V_T}{I_D}$ 

#### 1.6 Zener Diode

$$\bullet$$
 +  $v_D$   $v_D$ 

1. has 3 modes of operations:

Operation Condition Equivalent

Forward-biased  $v_D \leq V_T$   $v_D = -V_T$ 

Non-conducting  $-V_T < v_D < V_Z$  open circuit

Zener region  $v_D \ge V_Z$   $v_D = V_Z$ 

# 2 PN Juncion and BJT Operation

# 2.1 Semiconductor Fundamentals

1. The Silicon (14) Atom:

(a) has 4 valence electrons

(b) the semiconductor lattice has bounded valence electrons at 0K

(c) energy bands: electrons can occupy discrete energy levels

(d) there is a **band gap** between the valence band and conduction band

(e) at higher temperatures, an electron can gain enough energy to break the bonds

(f) when an electron leaves a bond, it leaves a positively charged hole

2. Groups by electrical properties:

(a) insulators: huge band gap

(b) conductor: conduction band and valence overlap

(c) semiconductor: small band gap that can be easily reached

3. Semiconductors:

(a) narrow band gap

(b) has 2 groups:

- i. intrinsic: just enough valence electrons to complete the matrix. either has group IV semiconductors (Si and Ge) or III-V compound (GaAs)
- ii. extrinsic: produced by doping intrinsic semiconductors
  - A. N-type: dopants have excess electrons. energy level just below the conduction band
  - B. P-type: dopants have less electrons. energy level just above the valence
- 4. Fermi level: hypothetical energy level where there is 50% probability that the level is occuppied by an electron at any given time
  - (a) intrinsic semiconductor: midway between  $E_C$  and  $E_V$
  - (b) extrinsic semiconductor:

i. N-type: closer to  $E_{C}$  ii. P-type: closer to  $E_{V}$ 

# 2.2 Carrier Actions in Semiconductors

- 1. Charge Carriers: the electrons and holes. units in coulombs (C)
- 2. Intrinsic semiconductor: n = p equal concentration of electrons and holes
- 3. N-type semiconductors:
  - (a) n > p
  - (b) majority charge carriers: electrons
  - (c) minority charge carriers: holes
- 4. P-type semiconductors:
  - (a) p > n
  - (b) majority charge carriers: holes
  - (c) minority charge carriers: electrons
- 5. Current: rate of movement of charge past a point or region. units in ampere (A). + is the direction of the hole/opposite the electron
- 6. Mobility: ability of charge carrier to move.  $\mu_e > \mu_h$
- 7. Factors that affect mobility:
  - (a) Scattering the random motion of charges. One mechanism is the *lattice scattering* when electrons bump with the vibrating lattice or other electrons and change directions
  - (b) another scattering mechanism is impurity scattering when dopant ions deflect charge carriers
  - (c) Temperature vs Scattering vs Mobility. At low temperatures, impurity scattering dominates (and with low mobility). at high temperatures, lattice scattering dominates (and low mobility). there is a temperature in the middle with maximum mobility. (like a parabolic log-log graph)
  - (d) Doping vs Scattering vs Mobility. more doping = more impurity scattering
  - (e) scattering has a net current of 0
- 8. There are 3 primary carrier actions:
  - (a) Generation and Recombination: generation = electron gains enough energy to break a covalent bond and leaves a hole. recombination = moving electron moves close to a hole and experience attractive force

- (b) Diffusion: electrons move from higher concentration/temperature to lower concentration/temperature. + diffusion is parallel to positive charges. becomes 0 when there is uniform distribution of charge carriers
- (c) Drift: caused by applied external voltage. modeled by a constant drift velocity  $v_d = \mu E$  (directly related to the electric field with the mobility as constant)
  - i.  $I_n = -Aqnv_{\text{n-drift}}$
  - ii.  $I_p = Aqpv_{\text{p-drift}}$

# 2.2.1 PN Junction

- 1. PN Junction: formed when in a single silicon crystal, one region is doped with donor dopants (N-type) and the other with acceptor dopants (P-type). PN Junction is the boundary.
- 2. Depletion Region: happens at the boundary when the electrons diffuse and recombine with the holes at the P-type region. This results to a potential difference (and thus an electric field) across the depletion region (points from N to P)
  - (a) drift current of minority carriers are drifted by this electric field
- 3. There are 3 junction operations:
  - (a) Open-circuit (equilibrium condition):
    - i. the diffusion current  $I_D$  is limited by the built in voltage  $V_0$  and equal to the drift current  $I_S$
- 3 BJTs as Amplifiers
- 4 MOSFETs as Amplifiers
- 5 Small Signal Analysis of Transistor Amplifiers
- **6 Amplifier Frequency Response**